

# EP 2132/C Epoxy Putty Technical Data Sheet

#### **Description**

EP 2132/C Epoxy Putty is a high quality structural adhesive filler based on epoxide resins and has been the cable gland industries standard for many years.

#### **Appearance**

The resin component is red in colour and the hardener component is beige/buff in colour.

## **Applications**

Cable joint sealing and filling (BASEEFA Approved). General purpose adhesive and stopping compound. Model and mould making.

### **Processing**

EP 2132/C is supplied as a two part system, equal parts of the resin and hardener components are mixed by kneading in the hands until an even colour is achieved. This can be best achieved by rolling and folding.

### **Handling Precautions**

EP 2132/C is intended to be mixed by hand, however all putties of this type are manufactured from reactive chemicals which can cause skin irritation especially to those people with a history of chemical allergy. Whilst these products have been used safely in industry for over 25 years we would recommend the use of gloves or a barrier cream.

#### **Usable Life**

This will depend upon the bulk mass and temperature. Approximate figures are;

25 gms wt:

2 hours @ 25°C.

25 gms wt:

3 hours @ 15°C.

#### Cure

This will depend upon the bulk mass and temperature. Approximate figures are;

25 gms wt:

12 hours @ 25°C.

25 gms wt:

24 hours @ 15°C.







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## **Mechanical Properties of Cured Mix**

Tensile strength BS 6319: Compressive strength BS 6319:

Hardness:

Specific Gravity @ 20 °C.:

2 days min. 30 Mpa 4 days min. 40 Mpa

min. 75 shore D

1.84 to 1.99

## **Electrical Properties of Cured Mix**

Calculated Comparative Tracking Index (CTI) 600V

### **Resistance Properties of Cured Mix**

Water absorption BS 2782/502S:

0.001%

Temperature:

-60 to 150°C.

This information is intended only for general guidance in the application of our products. It has been obtained by careful investigation and represents the present state of our knowledge and experience. Because of the wide number of possible methods of application and processing we are not able to assume responsibility in any one particular case for either the technical results or patent rights situation applicable to the country under consideration

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